# Analog Switch, High Bandwidth, Dual SPDT

The NLAS4717 is an advanced CMOS analog switch fabricated in sub-micron silicon gate CMOS technology. The device is a dual independent Single Pole Double Throw (SPDT) switch featuring two low  $R_{DS(on)}$  of 4.5  $\Omega$  at 3.0 V.

The device also features guaranteed Break-Before-Make (BBM) switching, assuring the switches never short the driver.

- The NLAS4717 is available in two small size packages:
- Micro10: 3.0 x 5.0 mm
- Flip-Chip-10: 2.0 x 1.5 mm

#### Features

- Low R<sub>DS(on)</sub>: 4.5 Ω @ 3.0 V
- Matching Between the Switches  $\pm 0.5 \Omega$
- Wide Low Voltage Range: 1.8 V to 5.5 V
- High Bandwidth > 40 MHz
- 1.65 V to 5.5 V Operating Range
- Low Threshold Voltages on Pins 4 and 8 (CTRL Pins)
- Ultra-Low Charge Injection  $\leq 6.0 \text{ pC}$
- Low Standby Current  $I_{CC} = 1.0 \text{ nA} (Max) @ T_A = 25^{\circ}C$
- OVT\* on Pins 4 and 8 (CTRL Logic Pins)
- Pb-Free Packages are Available

#### **Typical Applications**

- Cell Phones
- PDAs
- MP3s
- Digital Still Cameras

#### Important Information

- ESD Protection:
  - HBM = 2000 V, MM = 200 V
- Latchup Max Rating: 200 mA (Per JEDEC EIA/JESD78)
- Pin-to-Pin Compatible with MAX4717

#### \*OVT

• Overvoltage Tolerance (OVT) specific pins to operate higher than normal supply voltages, with no damage to the devices or to signal integrity.



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MARKING DIAGRAMS

> 4717 AYWW

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Α1



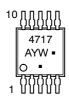
FLIP-CHIP-10 CASE 489AA





А

Y



= Assembly Location

= Year

W, WW = Work Week

= Pb-Free Package

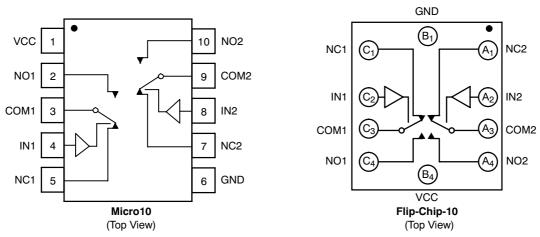
#### FUNCTION TABLE

IN_	NO_	NC_
0	OFF	ON
1	ON	OFF

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>			
NLAS4717FCT1	Flip-Chip-10	3000 / Tape & Reel			
NLAS4717FCT1G	Flip-Chip-10 (Pb-Free)	3000 / Tape & Reel			
NLAS4717MR2	Micro10	4000 / Tape & Reel			
NLAS4717MR2G	Micro10 (Pb-Free)	4000 / Tape & Reel			

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





#### MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V+	Positive DC Supply Voltage	-0.5 to +7.0	V
V <sub>IS</sub>	Analog Input Voltage ( $V_{NO}$ , $V_{NC}$ , or $V_{COM}$ ) (Note 1)	$-0.5 \leq V_{IS} \leq V_{CC} + 0.5$	V
V <sub>IN</sub>	Digital Select Input Voltage	$-0.5 \leq V_I \leq +7.0$	V
I <sub>IK</sub>	DC Current, Into or Out of Any Pin (Continuous)	± 100	mA
I <sub>PK</sub>	Peak Current (10% Duty Cycle)	±200	mA

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Signal voltage on NC, NO, and COM exceeding VCC or GND are clamped by the internal diodes. Limit forward diode current to maximum current rating.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Min	Max	Unit	
V+	DC Supply Voltage		1.8	5.5	V
V <sub>IN</sub>	Digital Select Input Voltage		GND	5.5	V
V <sub>IS</sub>	Analog Input Voltage (NC, NO, COM)		GND	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature Range		-40	+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise or Fall Time, SELECT V V	$\begin{array}{c} \text{CC} = 3.3 \text{ V} \pm 0.3 \text{ V} \\ \text{CC} = 5.0 \text{ V} \pm 0.5 \text{ V} \end{array}$	0 0	100 20	ns/V

#### ANALOG SWITCH DC CHARACTERISTICS

				-40 °C t	to +85°C	
Symbol	Parameter	Condition	V <sub>CC</sub> (V)	Min	Мах	Unit
V <sub>IH</sub>	Input Logic High Voltage	V <sub>OUT</sub> = 0.1 V I <sub>OUT</sub> ≤ 20 μA	1.65 to 2.2 2.7 to 3.6 4.5 to 5.5	V <sub>CC</sub> x 0.55 V <sub>CC</sub> x 0.5 2.0		V
V <sub>IL</sub>	Input Logic Low Voltage	V <sub>OUT</sub> = -V <sub>CC</sub> - 0.1 V I <sub>OUT</sub> ≤ 20 μA	1.65 to 2.2 2.7 to 3.6 4.5 to 5.5	- -	V <sub>CC</sub> x 0.2 V <sub>CC</sub> x 0.2 0.8	V
I <sub>IN</sub>	Input Leakage Current	V <sub>IN</sub> – V <sub>CC</sub> or GND	5.0	-100	+100	nA
V <sub>CC</sub>	Power Supply Range	All	-	1.65	5.5	V
ICC	Supply Current	V <sub>IN</sub> = V <sub>CC</sub> or GND I <sub>OUT</sub> = 0 μA	1.8 3.3 5.0	- -	1.0 1.0 1.0	μΑ
V <sub>IS</sub>	Analog Signal Range	Key parameter	-	0	V <sub>CC</sub>	V

#### ANALOG SWITCH CHARACTERISTICS - Digital Section (Voltages Referenced to GND)

				-	40 °C to +85°	С	
Symbol	Parameter	Condition	V <sub>CC</sub> (V)	Min	Тур	Max	Unit
R <sub>ON</sub>	ON Resistance (Note 2)	$V_{CC} = 3.0 \text{ V}$ $I_{COM} = 10 \text{ mA}$ $V_{NO} \text{ or } V_{NC} = V_{IH} \text{ or } V_{IL}$	3.0	-		4.5	Ω
		$V_{CC} = 5.0 \text{ V}$ $I_{COM} = 10 \text{ mA}$ $V_{NO} \text{ or } V_{NC} = V_{IH} \text{ or } V_{IL}$	5.0	-		3.5	
ΔR <sub>ON</sub>	ON Resistance Match Between Channels (Note 2 and 3)	$V_{CC} = 3.6 \text{ V}$ $I_{COM} = 10 \text{ mA}$ $V_{NO} \text{ or } V_{NC} = V_{IH} \text{ or } V_{IL}$	3.6	-	0.1	0.4	Ω
		$V_{CC} = 5.5 \text{ V}$ $I_{COM} = 10 \text{ mA}$ $V_{NO} \text{ or } V_{NC} = V_{IH} \text{ or } V_{IL}$	5.5				
R <sub>FLAT[ON]</sub>	ON Resistance Flatness (Note 4)	$I_{COM} = 10 \text{ mA}$ $V_{IS} = 0 \text{ to } V_{CC}$	3.0	-		1.5	Ω
		$I_{COM} = 10 \text{ mA}$ $V_{IS} = 0 \text{ to } V_{CC}$	5.5	-		1.36	
I <sub>NO_[OFF]</sub> I <sub>NC_[OFF]</sub>	NO_, NC_ Off-Leakage Current (Note 5)	$V_{CC} = 3.6 V$ $V_{COM} = 0.3 V \text{ or } 3.3 V$ $V_{NO} \text{ or } V_{NC} = 0.3 V \text{ or } 3.3 V$	3.6	-1.0	0.01	+1.0	nA
		$V_{CC} = 5.5 V$ $V_{COM} = 0 V \text{ or } 5.0 V$ $V_{NO} \text{ or } V_{NC} = 0 V \text{ or } 5.0 V$	5.5	-1.0	0.01	+1.0	
I <sub>СОМ</sub> [ОИ]	COM_ On-Leakage Current (Note 5)	$V_{CC} = 3.6 V$ $V_{COM} = 0.3 V \text{ or } 3.3 V$ $V_{NO} \text{ or } V_{NC} = 0.3 V \text{ or } 3.3 V$	3.6	-2.0	0.01	+2.0	nA
		$V_{CC} = 5.5 V$ $V_{COM} = 0 V \text{ or } 5.0 V$ $V_{NO} \text{ or } V_{NC} = 0 V \text{ or } 5.0 V$	5.5	-2.0	0.01	+2.0	

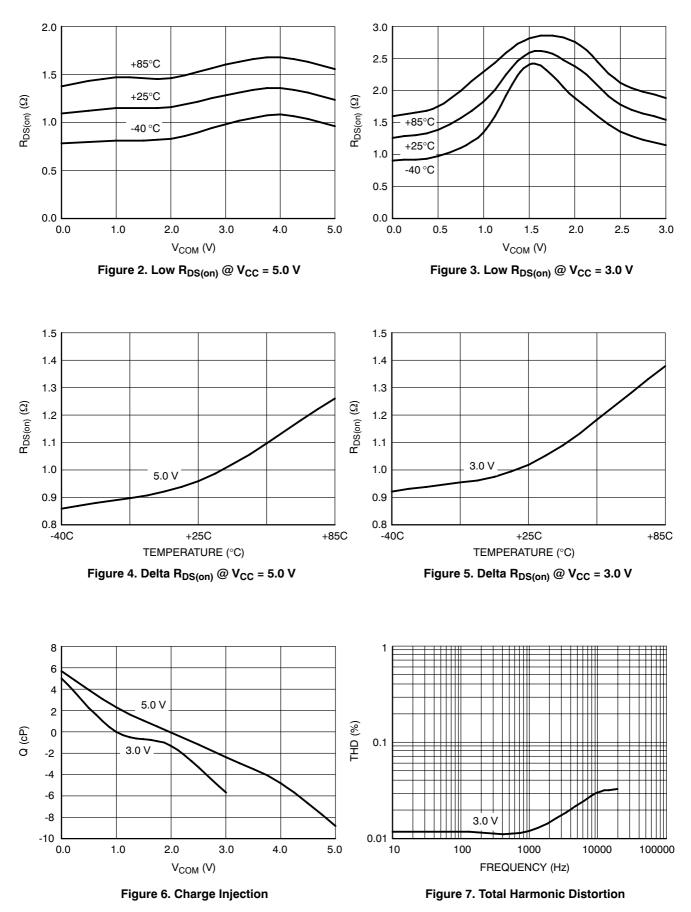
### ANALOG SWITCH AC CHARACTERISTICS

				-40 °C to +85°C		C	
Symbol	Parameter	Condition	V <sub>CC</sub> (V)	Min	Тур	Max	Unit
t <sub>ON</sub>	Turn-On Time		1.8 to 5.5	-	-	30	nS
toff	Turn-Off Time	$ \begin{array}{l} V_{NC\_},  V_{NO\_} = V_{IH} \text{ or } V_{IL} \\ R_{L} = 300 \; \Omega, \; C_{L} = 35 \; pF \\ V_{IN[X]} = V_{IH} \; or \; V_{IL} \end{array} $	1.8 to 5.5	-	-	40	nS
t <sub>BBM</sub>	Break-Before-Make Time Delay (Note 5)	V <sub>NC_</sub> , V <sub>NO_</sub> = 1.5 V R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF	-	-	8.0	-	nS
t <sub>SKEW</sub>	Skew (Note 5)	R <sub>S</sub> = 39 Ω, C <sub>L</sub> = 50 pF	-	-	0.15	2.0	nS

 $2. \ R_{ON} \ characterized \ for \ V_{CC} \ range \ (1.65 \ V \ to \ 5.5 \ V). \\ 3. \ \Delta R_{ON} = R_{ON}(MAX) \ - \ R_{ON}(MIN). \\ 4. \ R_{FLAT[ON]} = R_{ON}(MAX) \ - \ R_{ON}(MIN), \ measured \ over \ V_{CC} \ range. \\ 5. \ Guaranteed \ by \ design.$ 

## ANALOG SWITCH APPLICATION CHARACTERISTICS

				-	40 °C to +85°	С			
Symbol	Parameter	Condition	V <sub>CC</sub> (V)	Min	Тур	Max	Unit		
Q	Charge Injection	$V_{IN} = V_{CC} \text{ to GND}$ $R_{In} = 0 \Omega, C_L = 1.0 \text{ nF}$ $Q = C_L - \Delta V_{OUT}$	3.0 5.0	6.0 9.0		рС			
VISO	Off-Isolation	$f = 10 \text{ MHz}$ $V_{NO_{-}}, V_{NC_{-}} = 1.0 \text{ Vp-p}$ $R_{L} = 50 \Omega, C_{L} = 5.0 \text{ pF}$ $f = 1.0 \text{ MHz}$ $V_{NO_{-}}, V_{NC_{-}} = 1.0 \text{ Vp-p}$ $R_{L} = 50 \Omega, C_{L} = 5.0 \text{ pF}$	1.65 to 5.5	-50 -75					dB
VCT	Cross-Talk	f = 10 MHz V <sub>NO_</sub> , V <sub>NC_</sub> = 1.0 Vp-p R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 5.0 pF	1.65 to 5.5	-80		dB			
		f = 1.0 MHz V <sub>NO_</sub> , V <sub>NC_</sub> = 1.0 Vp-p R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 5.0 pF			-1 10				
BW	On-Channel -3.0 db Bandwidth	Signal = 0 dB $R_L$ = 50 $\Omega$ , $C_L$ = 5.0 pF	1.8 to 5.0	40			MHz		
THD	Total Harmonic Distortion	$V_{COM}$ = 2.0 Vp-p, RL = 600 $\Omega$ , T <sub>A</sub> = 25°C	-	0.02		%			
C <sub>NO_[OFF]</sub> C <sub>NC_[OFF]</sub>	NO_, NC_ OFF-Capacitance	F = 10 MHz	-	30		pF			
C <sub>NO_[ON]</sub> C <sub>NC_[ON]</sub>	NO_, NC_ ON-Capacitance	F = 10 MHz	-		110		pF		



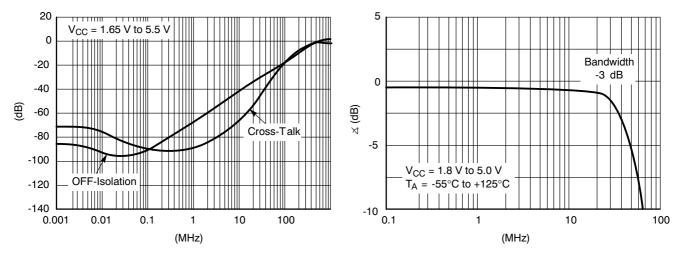
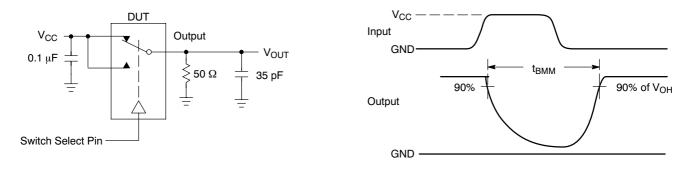
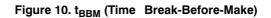
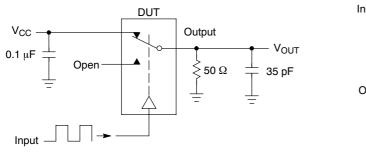


Figure 8. Frequency Response

Figure 9. Bandwidth and Phase







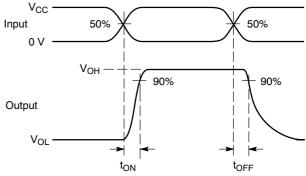
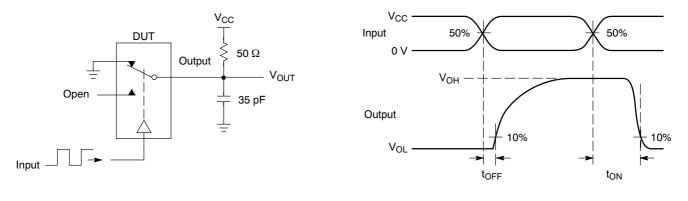
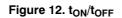
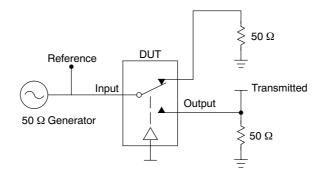


Figure 11. t<sub>ON</sub>/t<sub>OFF</sub>



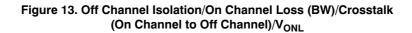




Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch.  $V_{ISO}$ , Bandwidth and  $V_{ONL}$  are independent of the input signal direction.

$$\begin{split} V_{ISO} &= \text{Off Channel Isolation} = 20 \text{ Log} \Big( \frac{V_{OUT}}{V_{IN}} \Big) \text{ for } V_{IN} \text{ at } 100 \text{ kHz} \\ V_{ONL} &= \text{On Channel Loss} = 20 \text{ Log} \left( \frac{V_{OUT}}{V_{IN}} \right) \text{ for } V_{IN} \text{ at } 100 \text{ kHz to } 50 \text{ MHz} \end{split}$$

Bandwidth (BW) = the frequency 3.0 dB below V<sub>ONL</sub> V<sub>CT</sub> = Use V<sub>ISO</sub> setup and test to all other switch analog input/outputs terminated with 50  $\Omega$ 



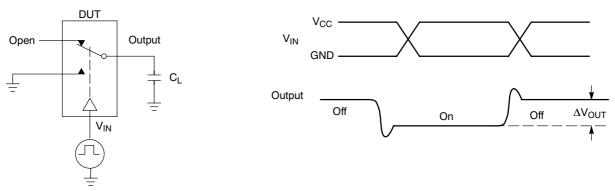


Figure 14. Charge Injection: (Q)



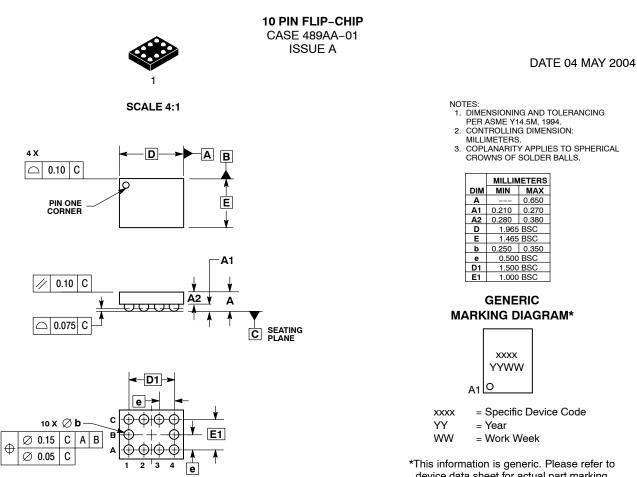


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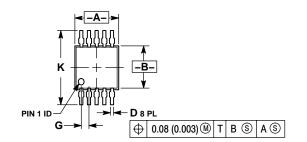
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DESCRIPTION:	10 PIN FLIP-CHIP		PAGE 1 OF 1		
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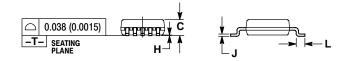




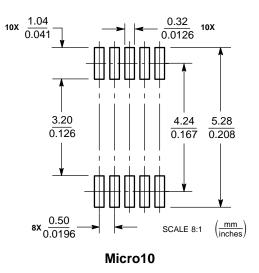
SCALE 2:1



Micro10 CASE 846B-03 ISSUE D



#### SOLDERING FOOTPRINT



#### DATE 07 DEC 2004

- NOTES: 1. DIMENSIONING AND TOLERANCING PER
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER. DIMENSION 'A' DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURDED GUIL, NOT EVOLUTIONS OR GATE 2. 3.
- MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  10 DIMENSION "B" DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION. SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
  10 ABSOLETE. NEW STANDARD 846B-02

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	2.90	3.10	0.114	0.122
В	2.90	3.10	0.114	0.122
С	0.95	1.10	0.037	0.043
D	0.20	0.30	0.008	0.012
G	0.50	BSC	0.020	BSC
н	0.05	0.15	0.002	0.006
J	0.10	0.21	0.004	0.008
K	4.75	5.05	0.187	0.199
L	0.40	0.70	0.016	0.028

#### GENERIC **MARKING DIAGRAM\***

	<u>00000</u>
	XXXX AYW O THITITI
xxxx	= Device Code
А	= Assembly Location
Y	= Year
W	= Work Week
•	= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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NEW STANDARD:		"CONTROLLED COPY" in red.		
DESCRIPTION:	Micro10		PAGE 1 OF 2	





PAGE 2 OF 2

	DEV/(SION	DATE
ISSUE	REVISION	DATE
0	RELEASED FOR PRODUCTION. REQ BY J. HOSKINS.	09 NOV 2000
А	DIM "D" WAS 0.25–0.4MM/0.10–0.016IN. ADDED NOTE 5. USED ON: WAS 10 LEAD TSSOP, PITCH 0.65 REQ BY J. HOSKINS.	13 NOV 2000
В	CHANGED "USED ON" WAS: 10 LEAD TSSOP, PITCH 0.50MM. REQ BY A. HAMID.	11 JUL 2001
С	CHANGED "D" DIMENSION MAX FROM 0.35 TO 0.30MM AND 0.014 TO 0.012IN. REQ BY D. TRUHITTE.	31 JUL 2003
D	ADDED FOOTPRINT INFORMATION. REQ. BY K. OPPEN.	07 DEC 2004

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